imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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RFM products are now Murata products.

SF2137E

869.00 MHz

SAW Filter

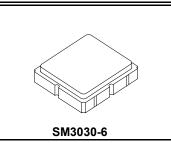
Steep Roll-off Filter for 869.00 MHz Unlicensed Band

Complies with Directive 2002/95/EC (RoHS)

No Matching Required for Operation in 50Ω Environment

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	17	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 Cycles/10 seconds Maximum	265	°C



Electrical Characteristics

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f _C			869.00		
Bandwidth, 1 dB				11		MHz
Bandwidth, 3 dB				17		
Insertion Loss, 868 to 870 MHz	IL			2.8	4.0	dB
Amplitude Ripple, 868 to 870 MHz				0.2	1.5	dB _{P-P}
Attenuation Referenced to 0 dB:						
825 to 828 MHz			40	47		
835 to 842 MHz			30	39		- dB
891 to 894 MHz			30	42		
910 to 913 MHz			40	47		
Source Impedance	Z _S			50		Ω
Load Impedance	ZL			50		Ω
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization, Y=year, WW=week, S=shift, Dot=pin 1 indicator	711, YWWS					
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel					
Reel Size 13 Inch	3000 Pieces/Reel					

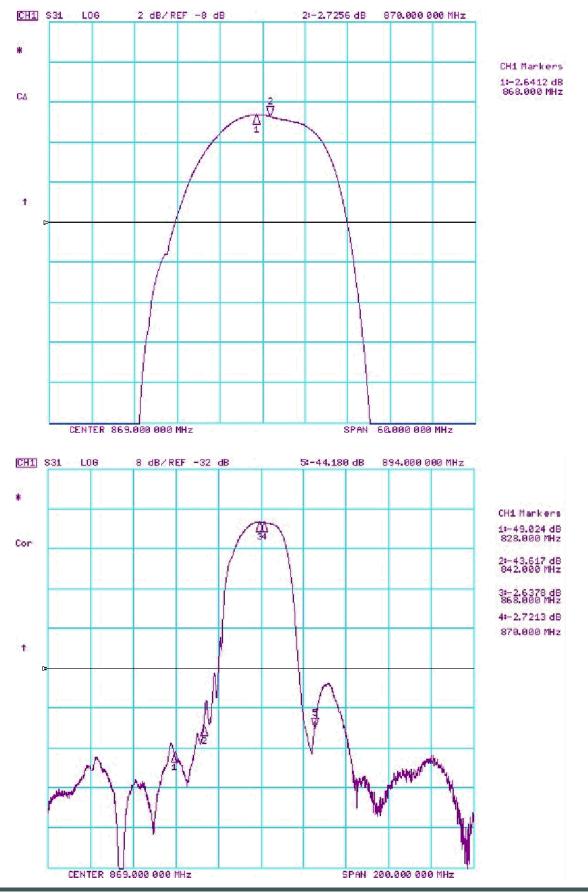
Electrical Connections

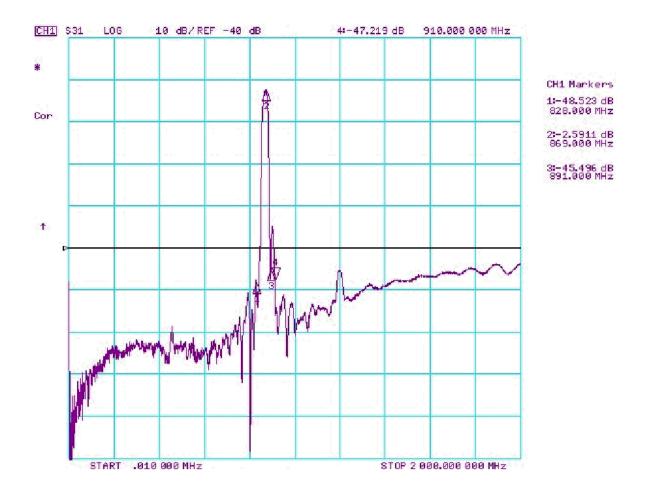
Connection	Terminals
Port 1	2
Port 2	5
Case Ground	All others



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

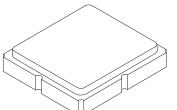
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer. 1
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. 2
- 3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- 4 The design, manufacturing process, and specifications of this filter are subject to change.
- 5
- US and international patents may apply. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd. 6.

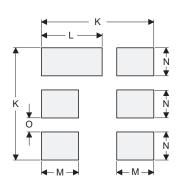




SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





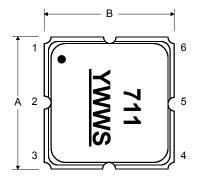
PCB Footprint Top View

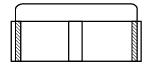
Dimension	mm			Inches		
Dimension	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
Н	1.37	1.50	1.63	0.054	0.059	0.064
Ι	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
К		3.20			0.126	
L		1.70			0.067	
М		1.05			0.041	
Ν		0.81			0.032	
0		0.38			0.015	

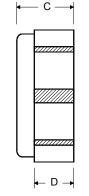
Case Materials

Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al ₂ O ₃ Ceramic			
Pb Free				

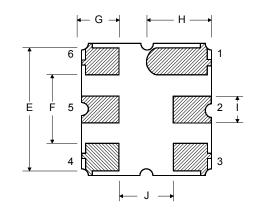
Top View





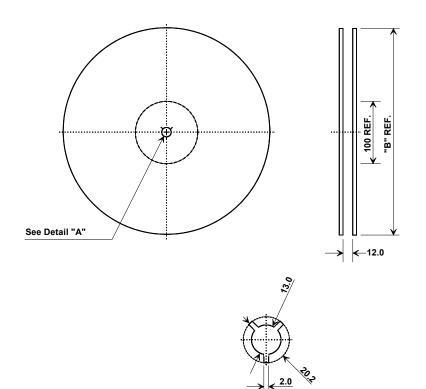






Case and PCB Footprint Dimensions

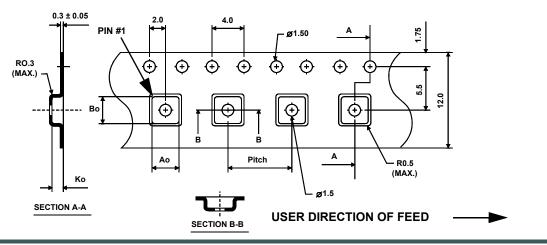
Tape and Reel Specifications



	"B"	Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions					
Ao	3.35 mm				
Во	3.35 mm				
Ко	1.40 mm				
Pitch	8.0 mm				
W	12.0 mm				



Typical Solder Reflow Profile

